# INDIUM CORPORATION®

# **Product Data Sheet**

# NC-771 Pb-Free, No-Clean Flux

#### Features

- Passes SIR test in the un-reflowed state
- · Halogen-free
- Backwards compatible with eutectic SnPb
- Ideal for high-reliability electronic circuitry
- · Benign, non-sticky, post reflow residue
- · Provides excellent wetting
- · Wide reflow process window

### Introduction

**NC-771** is a halogen-free, low-residue, all-purpose liquid flux that passes the SIR test in the un-reflowed state. It can be used in a standard SnPb or Pb-free rework or soldering process. In addition to the aesthetic benefits, the ultra-low post reflow residue is non-tacky and will not interfere with probe testing.

#### Process Recommendations

**NC-771** is a multi-purpose flux that can be used in an SMT rework process or almost any soldering application that requires the addition of a liquid flux. Typical application methods include a flux pen that allows you to apply a precise amount of flux to the solder joint. It can also be sprayed on for use in a selective soldering process or dispensed out a flux bottle. Care should be taken not to flood the solder joint and to apply the flux only to areas that will be exposed to complete heating from the solder iron or rework tool.

**NC-771** is designed for no-clean applications. However, the flux can be removed if necessary by using a commercially available flux remover.

# Physical Properties

| Test                 | Result    |
|----------------------|-----------|
| Color                | Clear     |
| Flash Point (°F TCC) | 12        |
| Smell                | Alcoholic |

## **Packaging**

NC-771 can be supplied in flux pens or in plastic containers.

### Shelf Life:

2 years from DOM when stored at 0-30°C



## Material Safety Data Sheet

The MSDS for this product can be found online at http://www.indium.com/msds

## Technical Support

Indium Corporation sets the industry standard in providing rapid response, on-site technical support for our customers worldwide. Indium Corporation's team of Technical Support Engineers can provide expertise in all aspects of materials science and semiconductor packaging process applications.

| J-STD-004A TESTING RESULTS  |   |
|---|---|
| Test  | Result  |
| Flux Type Classification SIR Copper Mirror Silver Chromate Fluoride Spot Test Corrosion Acid Value (nominal) Specific Gravity (nominal) Flux Solids (typical) | ORLO Pass Type L Pass Pass Pass 32.5 mg KOH/gm 0.825 5.0% |

All information is for reference only. Not to be used as incoming product specifications.

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